



## SECTION 8 CLOCKS AND POWER CONTROL

### 8.1 Overview

The main timing reference for the MPC555 / MPC556 can monitor any of the following:

- A crystal with a frequency of four MHz or 20 MHz
- An external frequency source with a frequency of 4 MHz
- An external frequency source at the system frequency

The system operating frequency is generated through a programmable phase-locked loop, the system PLL (SPLL). The SPLL is programmable in integer multiples of the input oscillator frequency to generate the internal (VCO/2) operating frequency. A pre-divider before the SPLL enables the user to divide the high frequency crystal oscillator. The SPLL VCO is twice the system frequency. The internal operating SPLL frequency should be at least 30 MHz. It can be divided by a power-of-two divider to generate the system operating frequencies.

In addition to the system clock, the clocks submodule provides the following:

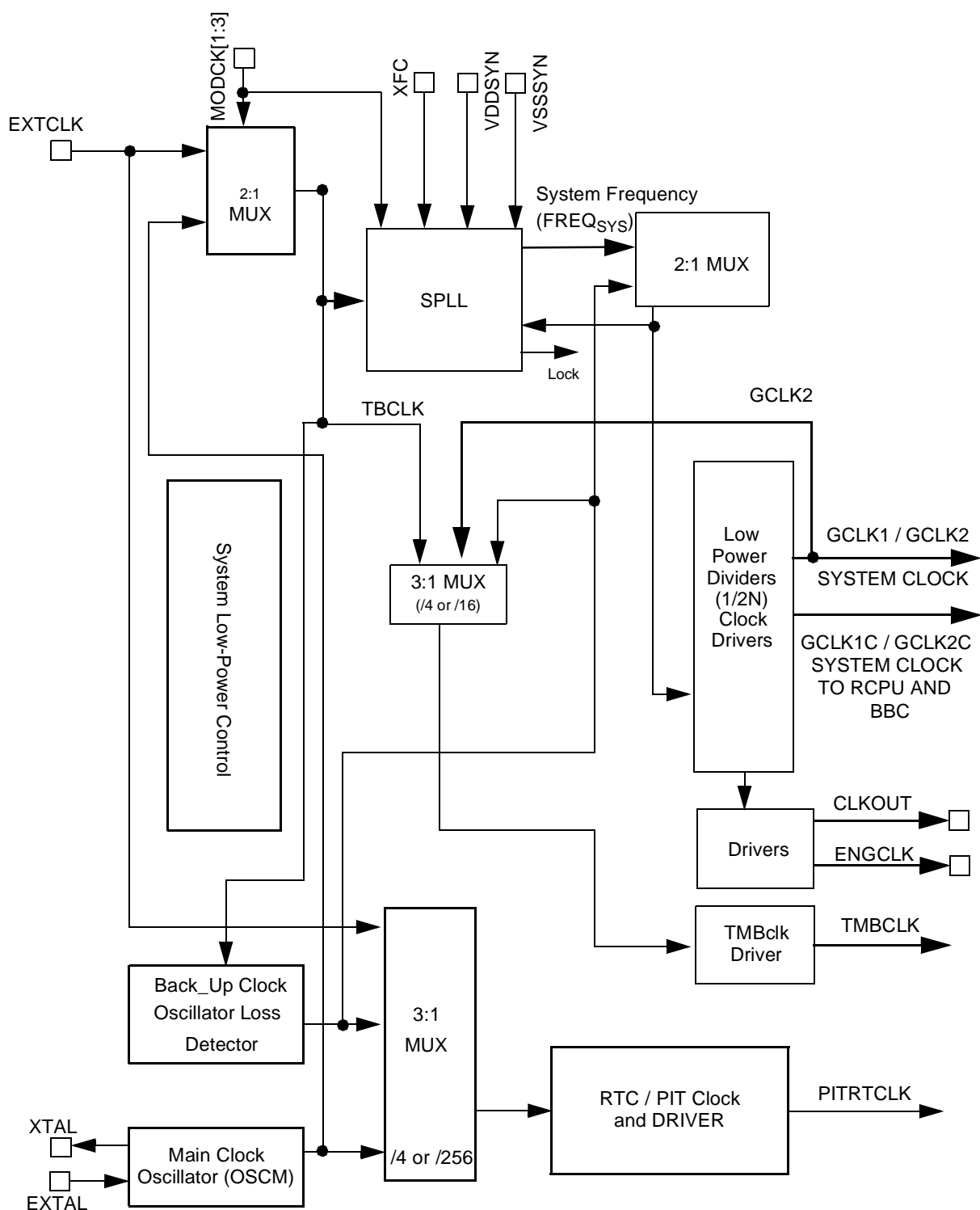
- TMBCLK to the time base (TB) and decremter (DEC)
- PITRTCLK to the periodic interrupt timer (PIT) and real-time clock (RTC)

The oscillator, TB, DEC, RTC, and the PIT are powered from the keep alive power supply (KAPWR) pin. This allows the counters to continue to count (increment/decrement) at the oscillator frequency even when the main power to the MCU is off. While the power is off, the PIT may be used to signal to the power supply IC to enable power to the system at specific intervals. This is the power-down wake-up feature. When the chip is not in power-down low-power mode, the KAPWR is powered to the same voltage value as the voltage of the I/O buffers and logic.

The MPC555 / MPC556 clock module consists of the main crystal oscillator (OSCM), the SPLL, the low-power divider, the clock generator, the system low-power control block, and the limp mode control block. The clock module receives control bits from the system clock control register (SCCR), change of lock interrupt register (COLIR), the low-power and reset-control register (PLPRCR), and the PLL.

All of the MPC555 peripherals on the IMB bus derive its clock timing from the UIMB module. The UIMB runs on the main system clock, but can divide the system frequency in half. See [12.3 Clock Module](#).

**Figure 8-1** illustrates the functional block diagram of the clock unit.



**Figure 8-1 Clock Unit Block Diagram**

## 8.2 System Clock Sources



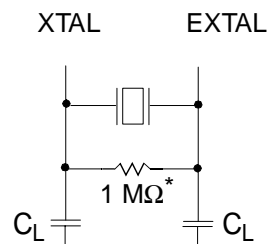
The system clock can be provided by the main system oscillator (OSCM), an external clock input, or the backup clock (BUCLK) on-chip ring oscillator, see [Figure 8-2](#).

The OSCM uses either a 4-MHz or 20-MHz crystal to generate the PLL reference clock. When the main system oscillator output is the timing reference to the system PLL, skew elimination between the XTAL/EXTAL pins and CLKOUT is not guaranteed.

The external clock input receives a clock signal from an external source. The clock frequency must be either in the range of 3 MHz – 5 MHz or at the system frequency of at least 15 MHz (1:1 mode). When the external clock input is the timing reference to the system PLL skew elimination between the EXTCLK pin and the CLKOUT is less than  $\pm 1$  ns.

The backup clock on-chip ring oscillator enables the MCU to function with a less precise clock. When operating from the backup clock, the MCU is in **limp mode**. This enables the system to continue minimum functionality until the system is fixed. The BUCLK frequency is approximately 7 MHz (see [APPENDIX G ELECTRICAL CHARACTERISTICS](#) for the complete frequency range).

For normal operation, at least one clock source (EXTCLK or OSCM) must be active. A configuration with both clock sources active is possible as well. At this configuration EXTCLK provides the OSCCLK and OSCM provides the PITRTCLK. The input of an unused timing reference (EXTCLK or EXTAL) must be grounded.



\*Resistor is not currently required on the board but space should be available for its addition in the future.

**Figure 8-2 Main System Oscillator (OSCM)**

## 8.3 System PLL

The PLL allows the processor to operate at a high internal clock frequency using a low frequency clock input, a feature which offers two benefits. Lower frequency clock input reduces the overall electromagnetic interference generated by the system, and the ability to oscillate at different frequencies reduces cost by eliminating the need to add an additional oscillator to a system.

The PLL can perform the following functions:

- Frequency multiplication

- Skew elimination
- Frequency division



### 8.3.1 Frequency Multiplication

The PLL can multiply the input frequency by any integer between one and 4096. The multiplication factor depends on the value of the MF[0:11] bits in the PLPRCR register. While any integer value from one to 4096 can be programmed, the resulting VCO output frequency must be at least 15 MHz. The multiplication factor is set to a predetermined value during power-on reset as defined in [Table 8-1](#).

### 8.3.2 Skew Elimination

The PLL is capable of eliminating the skew between the external clock entering the chip (EXTCLK) and both the internal clock phases and the CLKOUT pin, making it useful for tight synchronous timings. Skew elimination is active only when the PLL is enabled and programmed with a multiplication factor of one or two (MF = 0 or 1). The timing reference to the system PLL is the external clock input.

### 8.3.3 Pre-Divider

A pre-divider before the phase comparator enables additional system clock resolution when the crystal oscillator frequency is 20 MHz. The division factor is determined by the DIVF[0:4] bits in the PLPRCR.

### 8.3.4 PLL Block Diagram

As shown in [Figure 8-3](#), the reference signal, OSCCLK, goes to the phase comparator. The phase comparator controls the direction (up or down) that the charge pump drives the voltage across the external filter capacitor (XFC). The direction depends on whether the feedback signal phase lags or leads the reference signal. The output of the charge pump drives the VCO. The output frequency of the VCO is divided down and fed back to the phase comparator for comparison with the reference signal, OSCCLK. The MF values, zero to 4095, are mapped to multiplication factors of one to 4096. Note that when the PLL is operating in 1:1 mode (refer to [Table 8-1](#)), the multiplication factor is one (MF = 0). The PLL output frequency is twice the maximum system frequency. This double frequency is needed to generate GCLK1 and GCLK2 clocks. On power-up, with a four MHz or 20 MHz crystal and the default MF settings, System Frequency (FREQ<sub>SYS</sub>) will be 40 MHz and the system clock will be 20 MHz. The equation for System Frequency (FREQ<sub>SYS</sub>) is shown below:

$$\text{System Frequency (FREQ}_{\text{SYS}}) = \frac{\text{OSCCLK}}{\text{DIVF} + 1} \times (\text{MF} + 1) \times 2$$

#### NOTE

When operating with the backup clock, the system clock (and CLKOUT) is one-half of the ring oscillator frequency. (i.e., the system clock is a nominal seven MHz). The time base and PIT clocks will be twice the system clock frequency.

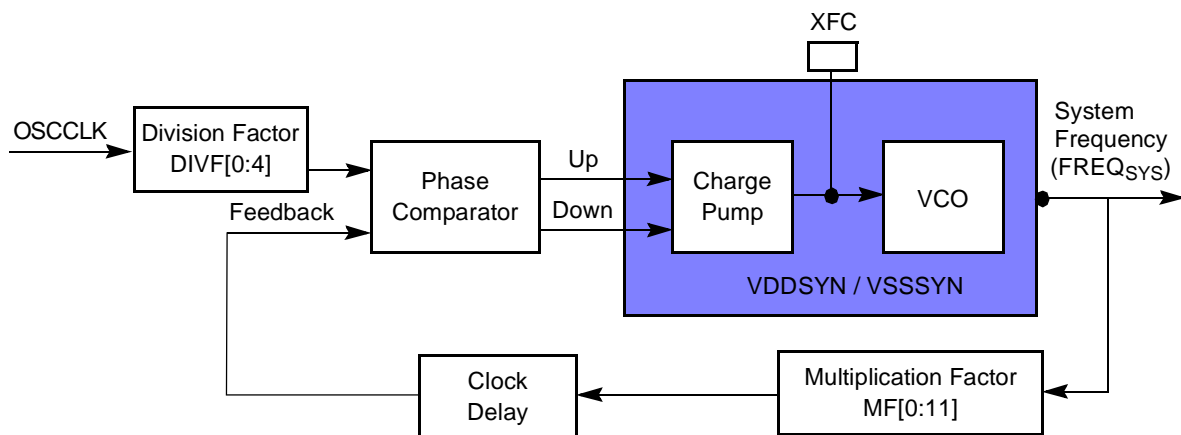
The PLL maximum lock time is determined by the input clock to the phase detector. The PLL locks within 500 input clock cycles.



#### NOTE

Upon initial system power up and after KAPWR is lost, an external circuit must assert power on reset ( $\overline{\text{PORESET}}$ ). If limp mode will be enabled during power-on reset,  $\overline{\text{PORESET}}$  must be asserted for at least 100,000 cycles of input PLL clock after a valid level has been reached on the KAPWR supply. If limp mode will be disabled,  $\overline{\text{PORESET}}$  should be asserted for approximately 3  $\mu\text{s}$  after a valid level has been reached on the KAPWR supply.

Whenever power-on reset is asserted, the MF bits are set according to [Table 8-1](#), and the DFNH and DFNL bits in SCCR are set to the value of 0 ( $\div 1$  and 2), respectively.



**Figure 8-3 System PLL Block Diagram**

#### 8.3.5 PLL Pins

The following pins are dedicated to the PLL operation:

- **VDDSYN** — Drain voltage. This is the  $V_{DD}$  dedicated to the analog PLL circuits. The voltage should be well-regulated and the pin should be provided with an extremely low impedance path to the  $V_{DD}$  power rail. VDDSYN should be bypassed to VSSSYN by a 0.1  $\mu\text{F}$  capacitor located as close as possible to the chip package.
- **VSSSYN** — Source voltage. This is the  $V_{SS}$  dedicated to the analog PLL circuits. The pin should be provided with an extremely low impedance path to ground. VSSSYN should be bypassed to VDDSYN by a 0.1  $\mu\text{F}$  capacitor located as close as possible to the chip package.
- **XFC** — External filter capacitor. XFC connects to the off-chip capacitor for the PLL filter. One terminal of the capacitor is connected to XFC, and the other terminal is connected to VDDSYN.

The off-chip capacitor must have the following values:

$$0 < MF + 1 < 4(680 \times (MF + 1) - 120) \text{ pF}$$

$$MF + 1 \geq 41100 \times (MF + 1) \text{ pF}$$

Where MF = the value stored on MF[0:11]. This is one less than the desired frequency multiplication.



## 8.4 System Clock During PLL Loss of Lock

At reset, until the SPLL is locked, the SPLL output clock is disabled.

During normal operation (once the PLL has locked), either the oscillator or an external clock source is generating the system clock. In this case, if loss of lock is detected and the LOLRE (loss of lock reset enable) bit in the PLPRCR is cleared, the system clock source continues to function as the PLL's output clock. The USIU timers can operate with the input clock to the PLL, so that these timers are not affected by the PLL loss of lock. Software can use these timers to measure the loss-of-lock period. If the timer reaches the user-preset software criterion, the MCU can switch to the backup clock by setting the switch to backup clock (STBUC) bit in the SCCR, provided the limp mode enable (LME) bit in the SCCR is set.

If loss of lock is detected during normal operation, assertion of  $\overline{\text{HRESET}}$  (for example, if LOLRE is set) disables the PLL output clock until the lock condition is met. During hard reset, the STBUC bit is set as long as the PLL lock condition is not met and clears when the PLL is locked. If STBUC and LME are both set, the system clock switches to the backup clock, and the chip operates in limp mode until STBUC is cleared.

Every change in the lock status of the PLL can generate a maskable interrupt.

### NOTE

When the VCO is the system clock source, chip operation is unpredictable while the PLL is unlocked. Note further that a switch to the backup clock is possible only if the LME bit in the SCCR is set.

## 8.5 Low-Power Divider

The output of the PLL is sent to a low-power divider block. (In limp mode the BUCLK is sent to a low-power divider block.) This block generates all other clocks in normal operation, but has the ability to divide the output frequency of the VCO before it generates the general system clocks sent to the rest of the MPC555 / MPC556. The PLL System Frequency ( $\text{FREQ}_{\text{SYS}}$ ) is always divided by at least 2.

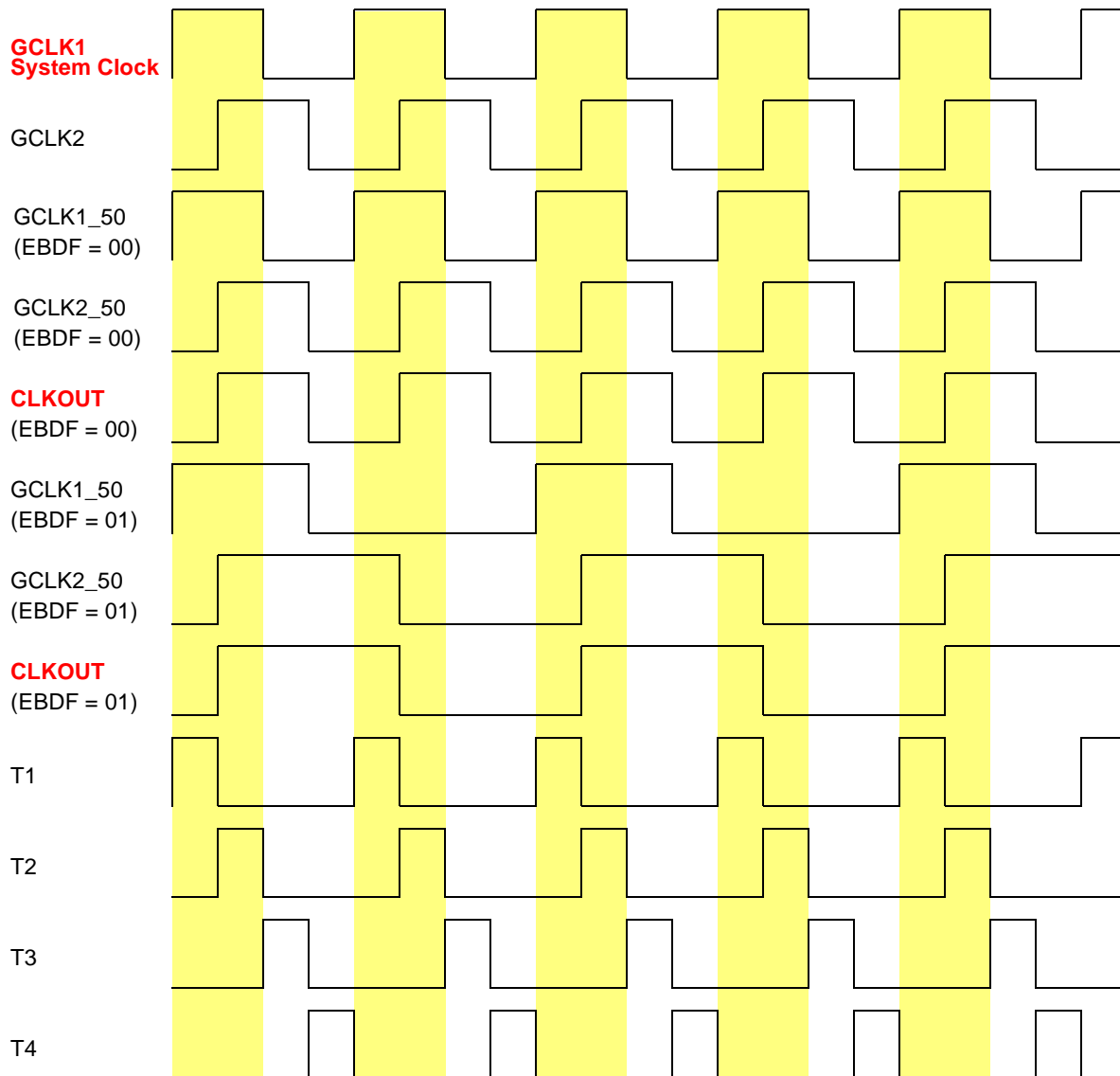
The purpose of the low-power divider block is to allow the user to reduce and restore the operating frequencies of different sections of the MPC555 / MPC556 without losing the PLL lock. Using the low-power divider block, the user can still obtain full chip operation, but at a lower frequency. This is called gear mode. The selection and speed of gear mode can be changed at any time, with changes occurring immediately.

The low-power divider block is controlled in the system clock control register (SCCR). The default state of the low-power divider is to divide all clocks by one. Thus, for a 40-MHz system, the general system clocks are each 40 MHz.

## 8.6 MPC555 / MPC556 Internal Clock Signals



The internal clocks generated by the clocks module are shown in [Figure 8-4](#). The clocks module also generates the CLKOUT and ENGCLK external clock signals. The PLL synchronizes these signals to each other. The PITRTCLK frequency and source are specified by the RTDIV and RTSEL bits in the SCCR. When the backup clock is functioning as the system clock, the backup clock is automatically selected as the time base clock source and is twice the MPC555 / MPC556 system clock.



**Figure 8-4 MPC555 / MPC556 Clocks**

Note that GCLK1\_50, GCLK2\_50, and CLKOUT can have a lower frequency than GCLK1 and GCLK2. This is to enable the external bus operation at lower frequencies (controlled by EBDF in the SCCR). GCLK2\_50 always rises simultaneously with

GCLK2. When  $DFNH = 0$ , GCLK2\_50 has a 50% duty cycle. With other values of  $DFNH$  or  $DFNL$ , the duty cycle is less than 50%. Refer to [Figure 8-7](#). GCLK1\_50 rises simultaneously with GCLK1. When the MPC555 / MPC556 is not in gear mode, the falling edge of GCLK1\_50 occurs in the middle of the high phase of GCLK2\_50. EBDP determines the division factor between GCLK1/GCLK2 and GCLK1\_50/GCLK2\_50.



During power-on reset, the MOCCK1, MODCK2, and MODCK3 pins determine the clock source for the PLL and the clock drivers. These pins are latched on the positive edge of  $\overline{PORESET}$ . Their values must be stable as long as this line is asserted. The configuration modes are shown in [Table 8-1](#). MODCK1 specifies the input source to the SPL (OSCM or EXTCLK). MODCK1, MODCK2, and MODCK3 together determine the multiplication factor at reset and the functionality of limp mode.

If the configuration of PITRTCLK and TMBCLK and the SPL multiplication factor is to remain unchanged in power-down low-power mode, the MODCK signals should not be sampled at wake-up from this mode. In this case the  $\overline{PORESET}$  pin should remain negated and  $\overline{HRESET}$  should be asserted during the power supply wake-up stage.

When MODCK1 is cleared, the output of the main oscillator (OSCM) is selected as the input to the SPL. When MODCK1 is asserted, the external clock input (EXTCLK) is selected as the input to the SPL. In all cases, the system clock frequency ( $freq_{gclk2}$ ) can be reduced by the  $DFNH[0:2]$  bits in the SCCR. Note that  $freq_{gclk2(max)}$  occurs when the  $DFNH$  bits are cleared.

The TBS bit in the SCCR selects the time base clock to be either the SPL input clock or GCLK2. When the backup clock is functioning as the system clock, the backup clock is automatically selected as the time base clock source.

The PITRTCLK frequency and source are specified by the RTDIV and RTSEL bits in the SCCR. When the backup clock is functioning as the system clock, the backup clock is automatically selected as the time base clock source.

When the  $\overline{PORESET}$  pin is negated (driven to a high value), the MODCK1, MODCK2, and MODCK3 values are not affected. They remain the same as they were defined during the most recent power-on reset.

[Table 8-1](#) shows the clock configuration modes during power-on reset ( $\overline{PORESET}$  asserted).

#### NOTE

The MODCK[1:3] are shared functions with  $\overline{IRQ}[5:7]$ . If  $\overline{IRQ}[5:7]$  are used as interrupts, the interrupt source should be removed during  $\overline{PORESET}$  to insure the MODCK pins are in the correct state on the rising edge of  $\overline{PORESET}$ .



**Table 8-1 Reset Clocks Source Configuration**



MODCK[1:3] <sup>1</sup>	LME	Default Values @ PORESET			SPLL Options
		MF + 1	PITCLK Division	TMBCLK Division	
000	0	513	4	4	Used for testing purposes.
001	0	1	256	16	Normal operation, PLL enabled. Main timing reference is freq(OSCM) = 20 MHz. Limp mode disabled.
010	1	5	256	4	Normal operation, PLL enabled. Main timing reference is freq(OSCM) = 4 MHz. Limp mode enabled.
011	1	1	256	16	Normal operation, PLL enabled. Main timing reference is freq(OSCM) = 20 MHz. Limp mode enabled.
100 101	0	1	256	16	Normal operation, PLL enabled. 1:1 Mode freqclkout(max) = freq(EXTCLK) Limp mode disabled.
110	0	5	256	4	Normal operation, PLL enabled. Main timing reference is freq(EXTCLK) = 3-5 MHz. Limp mode disabled.
111	1	1	256	16	Normal operation, PLL enabled. 1:1 Mode freqclkout(max) = freq(EXTCLK) Limp mode enabled.

**NOTES:**

1. For other implementations in the MPC500 family, MODCK2 could be inverted.

**NOTE**

The reset value of the PLL pre-divider is 1.

The values of the PITRTCLK clock division and TMBCLK clock division can be changed by software. The RTDIV bit value in the SCCR register defines the division of PITRTCLK. All possible combinations of the TMBCLK divisions are listed in [Table 8-2](#).

**Table 8-2 TMBCLK Divisions**

SCCR[TBS]	MF + 1	TMBCLK Division
1	—	16
0	1, 2	16
0	> 2	4

### 8.6.1 General System Clocks

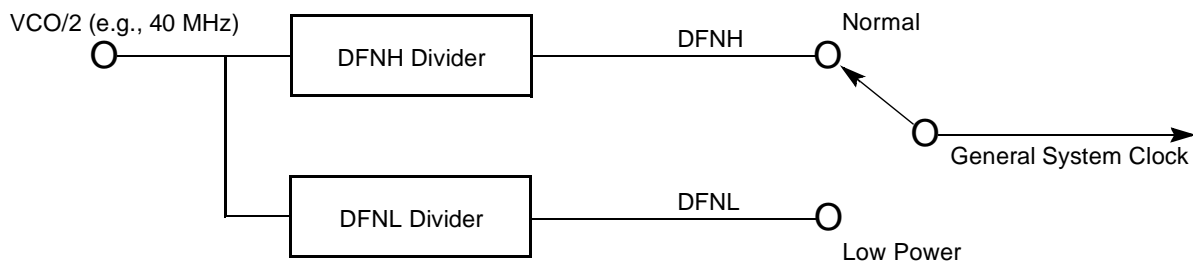
The general system clocks (GCLK1C, GCLK2C, GCLK1, GCLK2, GCLK1\_50, and GCLK2\_50) are the basic clock supplied to all modules and sub-modules on the MPC555 / MPC556. GCLK1C and GCLK2C are supplied to the RCPU and to the BBC. GCLK1C and GCLK2C are stopped when the chip enters the doze-low power mode. GCLK1 and GCLK2 are supplied to the SIU and the clock module. The external bus clock GCLK2\_50 is the same as CLKOUT. The general system clock defaults to VCO/

2 = 20 MHz (assuming a 20-MHz system frequency) with default power-on reset MF values.



The general system clock frequency can be switched between different values. The highest operational frequency can be achieved when the system clock frequency is determined by DFNH (CSRC bit in the PLPRCR is cleared) and DFNH = 0 (division by one). The general system clock can be operated at a low frequency (gear mode) or a high frequency. The DFNL bits in SCCR define the low frequency. The DFNH bits in SCCR define the high frequency.

The frequency of the general system clock can be changed dynamically with the system clock control register (SCCR), as shown in [Figure 8-5](#).



**Figure 8-5 General System Clocks Select**

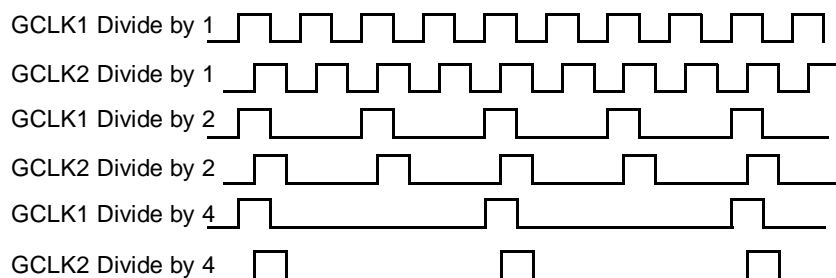
The frequency of the general system clock can be changed “on the fly” by software. The user may simply cause the general system clock to switch to its low frequency. However, in some applications, there is a need for a high frequency during certain periods. Interrupt routines, for example, may require more performance than the low frequency operation provides, but must consume less power than in maximum frequency operation. The MPC555 / MPC556 provides a method to automatically switch between low and high frequency operation whenever one of the following conditions exists:

- There is a pending interrupt from the interrupt controller. This option is maskable by the PRQEN bit in the SCCR.
- The (POW) bit in the MSR is clear in normal operation. This option is maskable by the PRQEN bit in the SCCR.

When neither of these conditions exists and the CSRC bit in PLPRCR is set, the general system clock switches automatically back to the low frequency.

Abrupt changes in the divide ratio can cause linear changes in the operating currents of the MPC555 / MPC556. Insure that the proper power supply filtering is available to handle this change instantaneously.

When the general system clock is divided, its duty cycle is changed. One phase remains the same (e.g., 12.5 ns @ 40 MHz) while the other become longer. Note that CLKOUT does not have a 50% duty cycle when the general system clock is divided. The CLKOUT waveform is the same as that of GCLK2\_50.



**Figure 8-6 Divided System Clocks Timing Diagram**

The system clocks GCLK1 and GCLK2 frequency is:

$$FREQ_{sys} = \frac{FREQ_{sysmax}}{(2^{DFNH}) \text{ or } (2^{DFNL+1})}$$

where  $FREQ_{sysmax} = \text{System Frequency } (FREQ_{SYS})/2$

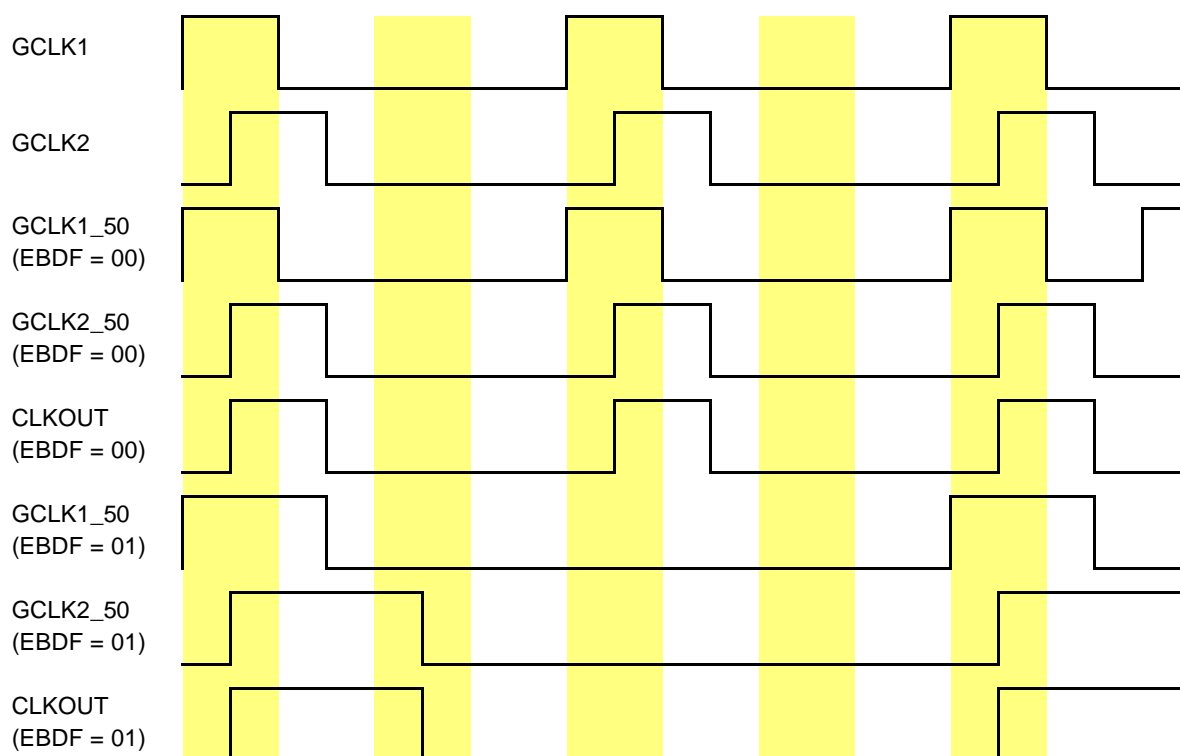
Therefore, the complete equation for determining the system clock frequency is:

$$\text{System Frequency } (FREQ_{SYS}) = \frac{OSCCLK}{DIVF + 1} \times \frac{(MF + 1)}{(2^{DFNH} \text{ or } 2^{DFNL + 1})} \times \frac{2}{2}$$

The clocks GCLK1\_50 and GCLK2\_50 frequency is:

$$FREQ_{50} = \frac{FREQ_{sysmax}}{(2^{DFNH}) \text{ or } (2^{DFNL + 1})} \times \frac{1}{EBDF + 1}$$

**Figure 8-7** shows the timing of USIU clocks when  $DFNH = 1$  or  $DFNL = 0$ .



**Figure 8-7 Clocks Timing For DFNH = 1 (or DFNL = 0)**

### 8.6.2 CLKOUT

CLKOUT has the same frequency as the general system clock (GCLK2\_50). Unlike the main system clock GCLK1/GCLK2 however, CLKOUT (and GCLK2\_50) represents the external bus clock, and thus will be one-half of the main system clock if the external bus is running at half speed (EBDF = 0b01). The CLKOUT frequency defaults to VCO/2. CLKOUT can drive full- or half-strength or be disabled. The drive strength is controlled in the system clock and reset-control register (SCCR). Disabling or decreasing the strength of CLKOUT can reduce power consumption, noise, and electromagnetic interference on the printed circuit board.

When the PLL is acquiring lock, the CLKOUT signal is disabled and remains in the low state (provided that BUCS = 0).

### 8.6.3 Engineering Clock

ENGCLK is an output clock with a 50% duty cycle. Its frequency defaults to VCO/128<sup>1</sup>, which is one-sixtyfourth of the main system frequency. ENGCLK frequency can be programmed to the main system frequency divided by a factor from one to 64, as controlled by the ENGDIV[0:5] bits in the SCCR. ENGCLK can drive full- or half-strength or be disabled (remaining in the high state). The drive strength is controlled by the EE-CLK[0:1] bits in the SCCR. Disabling ENGCLK can reduce power consumption, noise, and electromagnetic interference on the printed circuit board.

<sup>1</sup>. Mask sets prior to K62N default to VCO/4.

When the PLL is acquiring lock, the ENGCLK signal is disabled and remains in the low state (provided that BUCS = 0).



#### NOTE

Skew elimination between CLKOUT and ENGCLK is not guaranteed.

### 8.7 Clock Source Switching

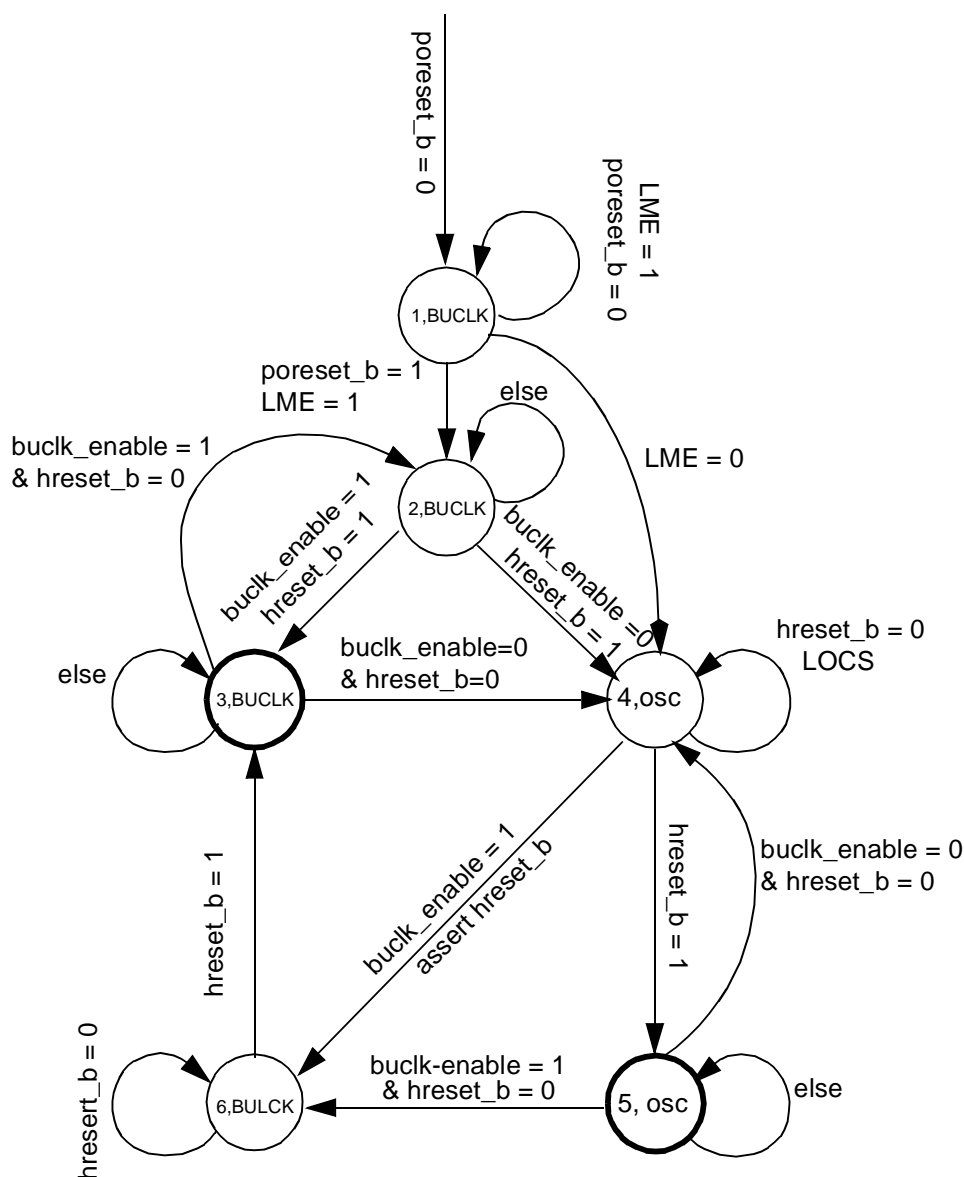
For limp mode support, clock source switching is supported. If for any reason the clock source for the chip is not functioning, the user has the option to switch the system clock to the backup clock ring oscillator, BUCLK.

This circuit consists of a loss-of-clock detector, which sets the LOCS status bit and LOCSS sticky bit in the PLPRCR. If the LME bit in the SCCR is set, whenever LOCS is asserted the clock logic switches the system clock automatically to BUCLK and asserts hard reset to the chip. Switching the system clock to BUCLK is also possible by software setting the STBUC bit in SCCR. Switching from limp mode to normal system operation is accomplished by clearing STBUC and LOCSS bits. This operation also asserts hard reset to the chip.

At  $\overline{\text{HRESET}}$  assertion, if the PLL output clock is not valid, the BUCLK will be selected until software clears LOCSS bit in SCCR. At  $\overline{\text{HRESET}}$  assertion, if the PLL output clock is valid, the system will switch to oscillator/external clock. If during  $\overline{\text{HRESET}}$  the PLL loses lock or the clock frequency becomes slower than the required value, the system will switch to the BUCLK. After  $\overline{\text{HRESET}}$  negation the PLL lock condition does not effect the system clock source selection.

If the LME bit is clear, the switch to the backup clock is disabled and assertion of STBUC bit is ignored. If the chip is in limp mode, clearing the LME bit switches the system to normal operation and asserts hard reset to the chip.

**Figure 8-8** describes the clock switching control logic. **Table 8-3** summarizes the status and control for each state.



**Figure 8-8 Clock Source Flow Chart**

### NOTES

BUCLK\_ENABLE = (STBUC | LOC) & LME lock indicates loss of lock status bit (LOCS) for all cases and loss of clock sticky bit (LOCSS) when state 3 is active. When BUCK\_ENABLE is changed, the chip asserts  $\overline{\text{HRESET}}$  to switch the system clock to BUCLK or PLL.

At  $\overline{\text{PORESET}}$  negation, if the PLL is not locked, the loss-of-clock sticky bit (LOCSS) is asserted, and the chip should operate with BUCLK.

The switching from state three to state four is accomplished by clearing the STBUC and LOCSS bits. If the switching is done when the PLL is not locked, the system clock will not oscillate until lock condition is met.



**Table 8-3 Status of Clock Source**

STATE	$\overline{\text{PORESET}}$	$\overline{\text{HRESET}}$	LME	LOCS (status)	LOCSS (sticky)	STBUC	BUCS	Chip Clock Source
1	0	0	1	0	0	0	1	BUCLK
2	1	0	1	0/1	0	0	1	BUCLK
3 <sup>1</sup>	1	1	1	x <sup>2</sup>	0/1	0/1	1	BUCLK
4	1	0	0/1	0	x <sup>2</sup>	0	0	Oscillator
5	1	1	0/1	0	x <sup>2</sup>	0	0	Oscillator
6	1	0	1	0/1	1	0/1	1	BUCLK

NOTES:

1. At least one of the two bits, LOCSS or BUCS, must be asserted (one) in this state.
2. X = don't care.

The default value of the LME bit is determined by MODCK[1:3] during assertion of the  $\overline{\text{PORESET}}$  line. The configuration modes are shown in [Table 8-1](#).

## 8.8 Low-Power Modes

The LPM and other bits in the PLPRCR are encoded to provide one normal operating mode and four low-power modes. In normal and doze modes the system can be in high state with frequency defined by the DFNH bits, or in the low state with frequency defined by the DFNL bits. The normal-high operating mode is the state out of reset. This is also the state of the bits after the low-power mode exit signal arrives.

There are four low-power modes:

- Doze mode
- Sleep mode
- Deep-sleep mode
- Power-down mode

### 8.8.1 Entering a Low-Power Mode

Low-power modes are enabled by setting the POW bit in the MSR and clearing the LPML (low-power mode lock) bit in the PLPRCR. Once enabled, a low-power mode is entered by setting the LPM bits to the appropriate value. This can be done only in one of the normal modes. The user cannot change the LPM or CSRC bits when the MCU is in doze mode.

[Table 8-6](#) summarizes the control bit descriptions for the different clock power modes.



**Table 8-4 Power Mode Control Bit Descriptions**

Power Mode	LPM[0:1]	CSRC	TEXPS
Normal-high	00	0	X
Normal-low ("gear")	00	1	X
Doze-high	01	0	X
Doze-low	01	1	X
Sleep	10	X	X
Deep-sleep	11	X	1
Power-down	11	X	0

### 8.8.2 Power Mode Descriptions

**Table 8-5** describes the power consumption, clock frequency, and chip functionality for each power mode.

**Table 8-5 Power Mode Descriptions**

Operation Mode	SPLL	Clocks	Functionality
Normal-high	Active	Full frequency $\div 2^{DFNH}$	Full functions not in use are shut off
Normal-low ("gear")	Active	Full frequency $\div 2^{DFNL+1}$	
Doze-high	Active	Full frequency $\div 2^{DFNH}$	Enabled: RTC, PIT, TB and DEC, memory controller Disabled: extended core (RCPU, BBC, FPU)
Doze-low	Active	Full frequency $\div 2^{DFNL+1}$	
Sleep	Active	Not active	Enabled: RTC, PIT, TB and DEC
Deep-sleep	Not active	Not active	
Power-down	Not active	Not active	
VDDSRAM	Not active	Not active	SRAM's data retention

### 8.8.3 Exiting from Low-Power Modes

Exiting from low-power modes occurs through an asynchronous interrupt or a synchronous interrupt generated by the memory controller. Any enabled asynchronous interrupt clears the LPM bits but does not change the PLPRCR[CSRC] bit.

The exit from normal-low, doze-high, and low modes and sleep mode to normal-high mode is accomplished with the asynchronous interrupt. The sources of the asynchronous interrupt are:

- Asynchronous wake-up interrupt from the interrupt controller
- RTC, PIT, or time base interrupts (if enabled)
- Decrementer exception

The system response to asynchronous interrupts is fast. The wake-up time from normal-low, doze-high, doze-low, and sleep mode due to an asynchronous interrupt or



decrementer exception is only three to four clock cycles of maximum system frequency. In 40-MHz systems, this wake-up requires 75 to 100 ns. The asynchronous wake-up interrupt from the interrupt controller is level sensitive one. It will therefore be negated only after the reset of interrupt cause in the interrupt controller.



The timers (RTC, PIT, time base, or decrementer) interrupts indication set status bits in the PLPRCR (TMIST). The clock module considers this interrupt to be pending asynchronous interrupt as long as the TMIST is set. The TMIST status bit should be cleared before entering any low-power mode.

**Table 8-7** summarizes wake-up operation for each of the low-power modes.

**Table 8-6 Power Mode Wake-Up Operation**

Operation Mode	Wake-up Method	Return Time from Wake-up Event to Normal-High
Normal-low ("gear")	Software or Interrupt	Asynchronous interrupts: 3-4 maximum system cycles Synchronous interrupts: 3-4 actual system cycles
Doze-high	Interrupt	
Doze-low	Interrupt	
Sleep	Interrupt	3-4 maximum system clocks
Deep-sleep	Interrupt	< 500 Oscillator Cycles 125 $\mu$ sec – 4 MHz 25 $\mu$ sec – 20 MHz
Power-down	Interrupt	< 500 oscillator cycles + power supply wake-up
V <sub>DDSRAM</sub>	External	Power-on sequence

### 8.8.3.1 Exiting from Normal-Low Mode

In normal mode (as well as doze mode), if the PLPRCR[CSRC] bit is set, the system toggles between low frequency (defined by PLPRCR[DFNL]) and high frequency (defined by PLPRCR[DFNH]). The system switches from normal-low mode to normal-high mode if either of the following conditions is met:

- An interrupt is pending from the interrupt controller; or
- The MSR[POW] bit is cleared (power management is disabled).

When neither of these conditions are met, the PLPRCR[CSRC] bit is set, and the asynchronous interrupt status bits are reset, the system returns to normal-low mode.

### 8.8.3.2 Exiting from Doze Mode

The system changes from doze mode to normal-high mode whenever an interrupt is pending from the interrupt controller.

### 8.8.3.3 Exiting from Deep-Sleep Mode

The system switches from deep-sleep mode to normal-high mode if any of the following conditions is met:

- An interrupt is pending from the interrupt controller
- An interrupt is requested by the RTC, PIT, or time base
- A decremter exception



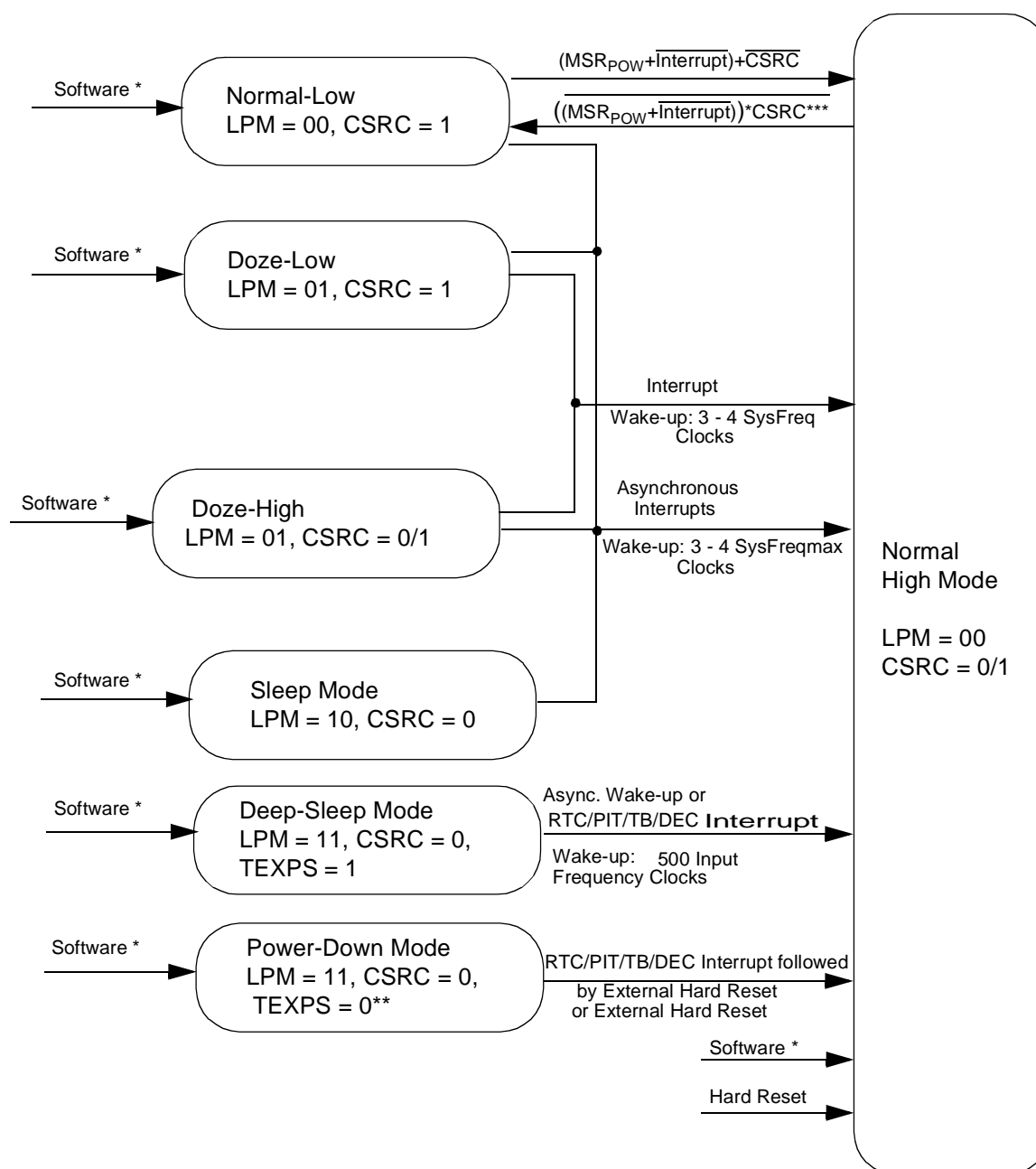
In deep-sleep mode the PLL is disabled. The wake-up time from this mode is up to 500 PLL input frequency clocks. In one-to-one mode the wake-up time may be up to 100 PLL input frequency clocks. For a PLL input frequency of 4 MHz, the wake-up time is less than 125  $\mu$ s.

#### 8.8.3.4 Exiting from Power-Down Mode

Exit from power-down mode is accomplished through hard reset. External logic should assert  $\overline{\text{HRESET}}$  in response to the TEXPS bit being set and TEXP pin being asserted. The TEXPS bit is set by an enabled RTC, PIT, time base, or decremter interrupt. The hard reset should be asserted for no longer than the time it takes for the power supply to wake-up in addition to the PLL lock time. When the TEXPS bit is cleared (and the TEXP signal is negated), assertion of hard reset sets the bit, causes the pin to be asserted, and causes an exit from power-down low-power mode. Refer to [8.9.3 Keep Alive Power](#) for more information.

#### 8.8.3.5 Low-Power Modes Flow

[Figure 8-9](#) shows the flow among the different power modes.



- \* Software is active only in normal-high/low modes
- \*\* TEXPS receives the zero value by writing one. Writing of zero has no effect on TEXPS.
- \*\*\* The switch from normal-high to normal-low is enable only if the conditions to asynchronous interrupt are cleared

**Figure 8-9 MPC555 / MPC556 Low-Power Modes Flow Diagram**

## 8.9 Basic Power Structure



### 8.9.1 Clock Unit Power Supply

KAPWR and VSS power the following clock unit modules: oscillator, PITRTCLK and TMBCLK generation logic, timebase, decremter, RTC, PIT, system clock control register (SCCR), low-power and reset-control register (PLPRCR), and reset status register (RSR). All other circuits are powered by the normal supply pins, VDDI, VDDL, VDDH and VSS. The power supply for each block is listed in [Table 8-7](#).

**Table 8-7 Clock Unit Power Supply**

Circuit	Power Supply
CLKOUT SPLL (digital), System low-power control Internal logic Clock drivers	VDDL/VDDI
SPLL (analog)	VDDSYN
Main oscillator Reset machine Limp mode mechanism Register control SCCR, PLLRCR and RSR RTC, PIT, TB, and DEC	KAPWR
SRAM, VDDSRAM detector, VSRMCR	VDDSRAM

The following are the relations between different power supplies:

- $VDDL = VDDI = VDDSYN = VDDF = 3.3\text{ V} \pm 10\%$
- $KAPWR \geq VDDL - 0.2\text{ V}$  (during normal operation)
- $VDDSRAM \geq VDDL - 0.3\text{ V}$  (during normal operation)
- $VDDSRAM \geq 1.4\text{ V}$  (during standby operation)
- $VPP \geq VDDL - 0.3\text{ V}$ , but  $VPP - VDDL < 4.0\text{ volts}$

### 8.9.2 Chip Power Structure

The MPC555 / MPC556 provides a wide range of possibilities for power supply connections. [Figure 8-10](#) illustrates the different power supply sources for each of the basic units on the chip.

#### 8.9.2.1 VDDL

The I/O buffers and logic are fed by a 3.3-V power supply.

#### 8.9.2.2 VDDI

VDDI powers the internal logic of the MPC555 / MPC556, nominally 3.3 V.

### 8.9.2.3 VDDSYN, VSSSYN

The charge pump and the VCO of the SPLL are fed by a separate 3.3-V power supply (VDDSYN) in order to improve noise immunity and achieve a high stability in its output frequency. VSSSYN provides an isolated ground reference for the PLL.



### 8.9.2.4 KAPWR

The oscillator, time base counter, decremter, periodic interrupt timer and the real-time clock are fed by the KAPWR rail. This allows the external power supply unit to disconnect all other sub-units of the MCU in low-power deep-sleep mode. The TEXP pin (fed by the same rail) can be used by the external power supply unit to switch between sources. The  $\overline{\text{IRQ}}[6:7]/\text{MODCK}[2:3]$ ,  $\overline{\text{IRQ}}5/\text{MODCK}1$ , XTAL, EXTAL, EXTCLK,  $\overline{\text{PORESET}}$ ,  $\overline{\text{HRESET}}$ ,  $\overline{\text{SRESET}}$ , and RSTCONF/TEXP input pins are powered by KAPWR. Circuits, including pull-up resistors, driving these inputs should be powered by KAPWR.

### 8.9.2.5 VDDA, VSSA

VDDA supplies power to the analog subsystems of the QADC\_A and QADC\_B modules; it is nominally 5.0 V. VDDA is the ground reference for the analog subsystems.

### 8.9.2.6 VPP

VPP supplies the programming and erase voltage for the CMF Flash modules. It is nominally 5.0 V for program or erase operations and can be lowered to a nominal 3.3 V for read operations.

### 8.9.2.7 VDDF, VSSF

VDDF provides internal power to the CMF flash module; it should be a nominal 3.3 V. VSSF provides an isolated ground for the CMF flash module.

### 8.9.2.8 VDDH

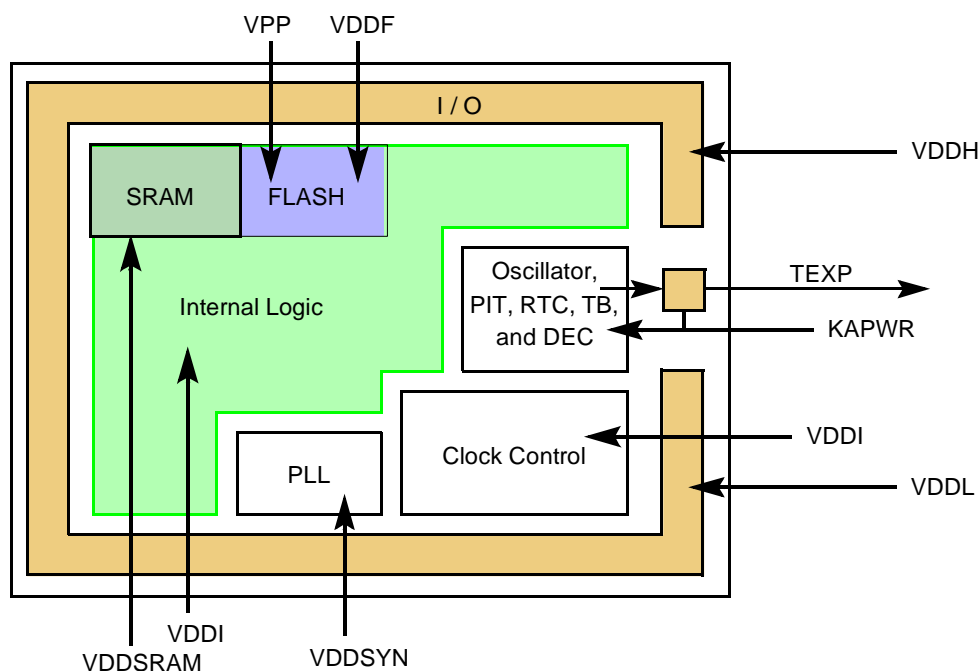
VDDH provides power for the 5-V I/O operations. It is a nominal 5.0 V.

### 8.9.2.9 VDDSRAM

VDDSRAM supplies power to the 26-Kbyte SRAM module and the DPTRAM. It can be used to keep the contents on the SRAM stable while the rest of the MPC555 / MPC556 is powered down for standby operation.

### 8.9.2.10 VSS

VSS provides the ground reference for the MPC555 / MPC556.

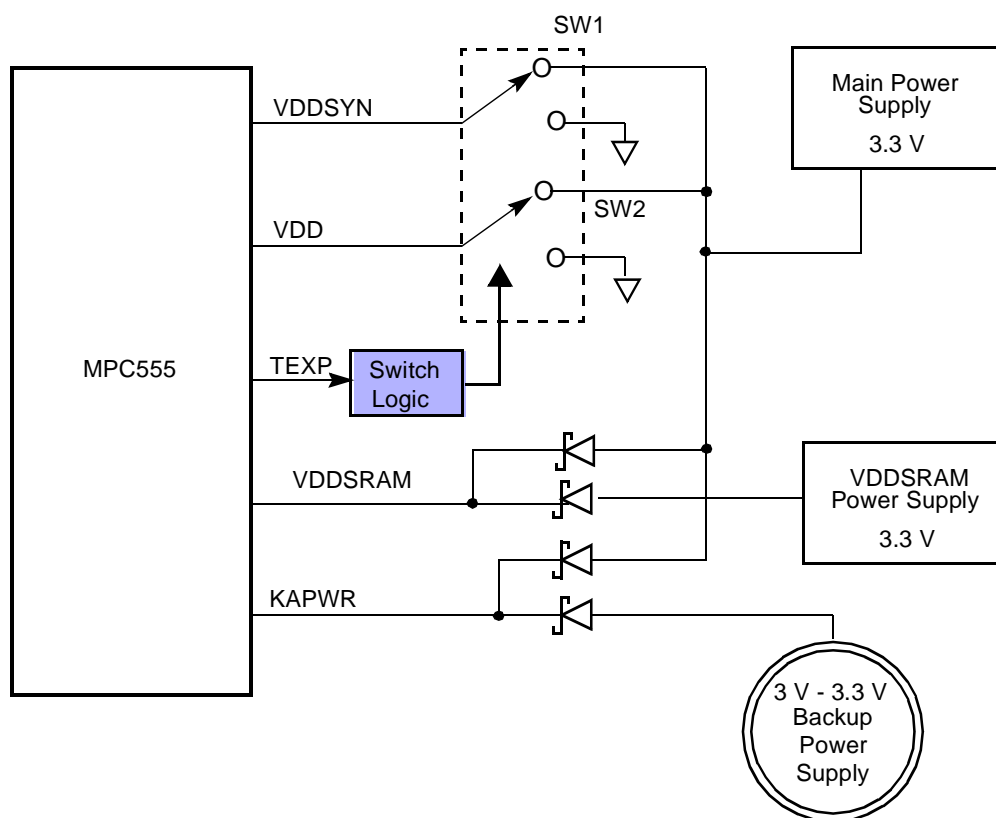


**Figure 8-10 Basic Power Supply Configuration**

### 8.9.3 Keep Alive Power

#### 8.9.3.1 Keep Alive Power Configuration

**Figure 8-11** illustrates an example of a switching scheme for an optimized low-power system. SW1 and SW2 can be unified in only one switch if VDDSYN and VDDI/VDDL are supplied by the same source.



**Figure 8-11 External Power Supply Scheme**

The MPC555 / MPC556 asserts the TEXP signal, if enabled, when the RTC or TB time value matches the value programmed in the associated alarm register or when the PIT or DEC value reaches zero. The TEXP signal is negated when the TEXPS status bit is written to one.

The KAPWR power supply feeds the main crystal oscillator (OSCM). The condition for the main crystal oscillator stability is that the power supply value changes slowly. The maximum slope must be less than 5 mV per oscillation cycle ( $\tau > 200\text{-}300/\text{freq}_{\text{oscm}}$ ).

### 8.9.3.2 Keep Alive Power Registers Lock Mechanism

The USIU timer, clocks, reset, power, decremter, and time base registers are powered by the KAPWR supply. When the main power supply is disconnected after power-down mode is entered, the value stored in any of these registers is preserved. If power-down mode is not entered before power disconnect, there is a chance of data loss in these registers. To minimize the possibility of data loss, the MPC555 / MPC556 includes a key mechanism that ensures data retention as long as a register is locked. While a register is locked, writes to this register are ignored.

Each of the registers in the KAPWR region have a key that can be in one of two states: open or locked. At power-on reset the following keys are locked: RTC, RTSEC, RT-

CAL, and RTCSC. All other registers are unlocked. Each key has an address associated with it in the internal memory map.



A write of 0x55CCAA33 to the associated key register changes the key to the open state. A write of any other data to this location changes the key to the locked state.

### NOTE

A read of a key register may be interpreted as a write of a lock value and may lock the associated register.

The key registers are write-only. A read of the key register has undefined side effects and may be interpreted as a write that locks the associated register.

**Table 8-8** lists the registers powered by KAPWR and the associated key registers.

**Table 8-8 KAPWR Registers and Key Registers**

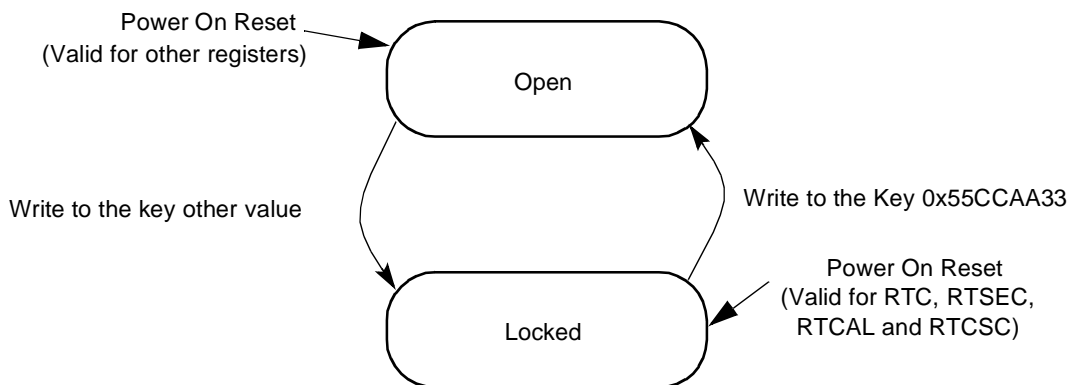
KAPWR Register		Associated Key Register	
Address or SPR Number	Register	Address	Register
0x2F C200	Time Base Status and Control (TBSCR) See <a href="#">Table 6-16</a> for bit descriptions.	0x2F C300	Time Base Status and Control Key (TBSCRK)
0x2F C204	Time Base Reference 0 (TBREF0) See <a href="#">6.13.4.3 Time Base Reference Registers</a> for bit descriptions.	0x2F C304	Time Base Reference 0 Key (TBREF0K)
0x2F C208	Time Base Reference 1 (TBREF1) See <a href="#">6.13.4.3 Time Base Reference Registers</a> for bit descriptions.	0x2F C308	Time Base Reference 1 Key (TBREF1K)
0x2F C220	Real Time Clock Status and Control (RTCSC) See <a href="#">Table 6-17</a> for bit descriptions.	0x2F C320	Real Time Clock Status and Control Key (RTCSCK)
0x2F C224	Real Time Clock (RTC) See <a href="#">6.13.4.6 Real-Time Clock Register (RTC)</a> for bit descriptions.	0x2F C324	Real Time Clock Key (RTCK)
0x2F C228	Real Time Alarm Seconds (RTSEC) Reserved	0x2F C328	Real Time Alarm Seconds Key (RTSECK)
0x2F C22C	Real Time Alarm (RTCAL) See <a href="#">6.13.4.7 Real-Time Clock Alarm Register (RTCAL)</a> for bit descriptions.	0x2F C32C	Real Time Alarm Key (RTCALK)
0x2F C240	PIT Status and Control (PISCR) See <a href="#">Table 6-18</a> for bit descriptions.	0x2F C340	PIT Status and Control Key (PISCRK)
0x2F C244	PIT Count (PITC) See <a href="#">Table 6-19</a> for bit descriptions.	0x2F C344	PIT Count Key (PITCK)
0x2F C280	System Clock Control Register (SCCR) See <a href="#">Table 8-9</a> for bit descriptions.	0x2F C380	System Clock Control Key (SCCRK)
0x2F C284	PLL Low-Power and Reset-Control Register (PLPRCR) See <a href="#">Table 8-10</a> for bit descriptions.	0x2F C384	PLL Low-Power and Reset-Control Register Key (PLPRCRK)
0x2F C288	Reset Status Register (RSR) See <a href="#">Table 7-3</a> for bit descriptions.	0x2F C388	Reset Status Register Key (RSRK)



**Table 8-8 KAPWR Registers and Key Registers (Continued)**

KAPWR Register		Associated Key Register	
Address or SPR Number	Register	Address	Register
SPR 22	Decrementer See <a href="#">3.9.5 Decrementer Register (DEC)</a> for bit descriptions.	0x2F C30C	Time Base and Decrementer Key (TBK)
SPR 268, 269, 284, 285,	Time Base See <a href="#">Table 3-11</a> and <a href="#">Table 3-14</a> for bit descriptions.		

**Figure 8-12** illustrates the process of locking or unlocking a register powered by KAPWR.



**Figure 8-12 Keep Alive Register Key State Diagram**

## 8.10 VDDSRAM Supply Failure Detection

A special circuit for VDDSRAM supply failure detection is provided. In the case of supply failure detection, the dedicated sticky bits LVSRs in the VSRMCR register are asserted. Software can read or clear these bits. The user should enable the detector and then clear these bits. If the user reads any of the LVSR bits as one, then a power failure of VDDSRAM has occurred. The circuit is capable of detecting supply failure below 2.6 V. Also, enable/disable control bit for the VDDSRAM detector may be used to disconnect the circuit and save the detector power consumption.

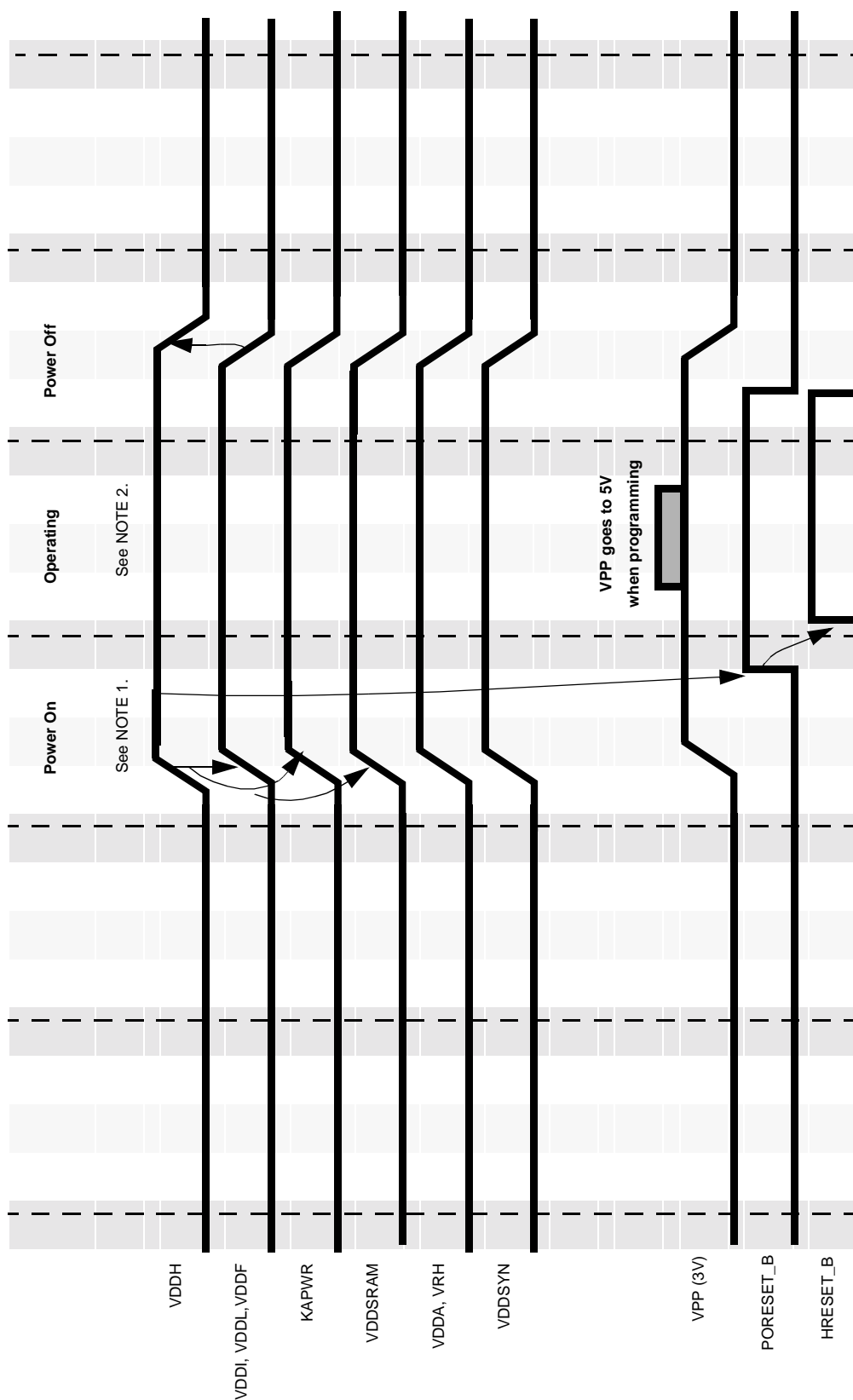
## 8.11 Power Up/Down Sequencing

**Figure 8-13** and **Figure 8-14** detail the power-up sequencing for MPC555 / MPC556 during normal operation. Note that for each of the conditions detailing the voltage relationships the absolute bounds of the minimum and maximum voltage supply cannot be violated, i.e. the value of VDDL cannot fall below 3.0 V or exceed 3.6 V and the value of VDDH cannot fall below 4.5 V or exceed 5.5 V for normal operation. Further information detailing the functionality of the VPP signal for flash program and erase is outlined in [19.9.2 FLASH Program/Erase Voltage Conditioning](#). Power consumption during power up sequencing can not be specified prior to evaluation and charac-

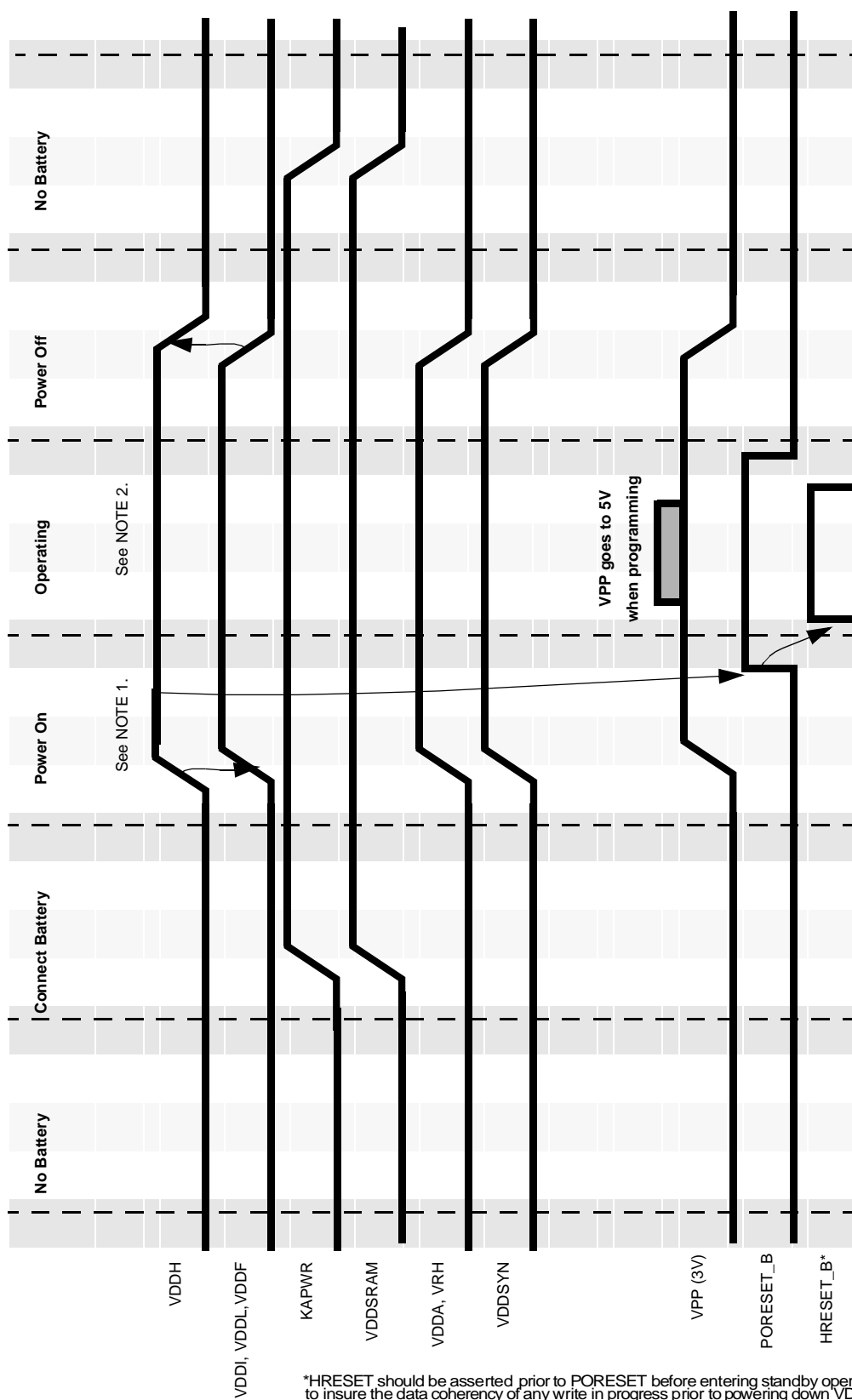
terization of production silicon. The goal is to keep the power consumption during power up sequencing below the operating power consumption.



During the power down sequence the user needs to assert  $\overline{\text{PORESET}}$  while VDDI and VDDL are at a voltage equal or greater to 3 V. Below this voltage the power supply chip can be turned off. If the turn off voltage of the power supply chip is greater than 0.74 V for the 3-V supply and greater than 0.8 V for the 5-V supply, then the circuitry inside the MPC555 / MPC556 will act as a load to the respective supply and will discharge the supply line down to these values. Since the 3-V logic represents a larger load to the supply chip, the 3-V supply line will decay faster than the 5-V supply line.



**Figure 8-13 No Standby, No KAPWR, All System Power On/Off**



**Figure 8-14 Standby and KAPWR, Other Power On/Off**

## NOTE

The following notes apply to **Figure 8-13** and **Figure 8-14** above:



1.  $VDDH \geq VDDL - 0.35 \text{ V}$  (0.5 V max. at temperature extremes)  
 $VPP \leq VDDH + 0.5 \text{ V}$  AND  $VPP \geq VDDL - 0.35 \text{ V}$   
(The delta  $VPP - VDDL$  must be  $\leq 3.6 \text{ V}$  during power on or off)

VDDA can lag VDDH, and VDDSYN can lag VDDL, but both must be at a valid level before resets are negated.

2. If keep alive functions are NOT used, then when system power is on:

$$KAPWR = VDDSRAM = VDDL \pm 0.35 \text{ V}$$

3. If keep alive functions ARE used, then

$KAPWR = VDDSRAM = VDDL = 3.3 \text{ V} \pm 0.35 \text{ V}$  when system power is on  
 $VDDSRAM \geq 1.8 \text{ V}$  and optionally  $KAPWR = 3.3 \text{ V} \pm 0.3 \text{ V}$  when system power is off

Normal system power is defined as

$$VDDL = VDDI = VDDF = VDDSYN = VPP = VDDSRAM = KAPWR = 3.3 \pm 0.3 \text{ V} \text{ and } VDDA = VDDH = 5.0 \pm 0.5 \text{ V}$$

Flash programming requirements are the same as normal system power, except  $VPP = 5.0 \pm 0.25 \text{ V}$

4. Do not hold the 3-V supplies at ground while VDDH/VDDA is ramping to 5 V.
5. If 5 V is applied before the 3-V supply, all 5-V outputs will be in indeterminate states until the 3-V supply reaches a level that allows reset to be distributed throughout the device

## 8.12 Clocks Unit Programming Model

### 8.12.1 System Clock Control Register (SCCR)

The SPLL has a 32-bit control register, SCCR, which is powered by keep-alive power.



#### SCCR — System Clock Control Register

0x2F C280

MSB 0	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15
DBCT	COM		DCSLR	MFPDL	LPML	TBS	RTDIV <sup>2</sup>	STBUC	RE-SERVED	PRQEN	RTSEL	BUCS	EBDF		LME

POWER-ON RESET:

1 0 ID2<sup>1</sup> 0 0 0 0 1<sup>2</sup> 0 0 1 EQ2<sup>3</sup> ID[13:14]<sup>1</sup> EQ3<sup>4</sup>

HARD RESET:

U 0 ID2<sup>1</sup> U 0 0 U U U 0 1 U U ID[13:14]<sup>1</sup> U

16	17	18	19	20	21	22	23	24	25	26	27	28	29	30	LSB 31
EECLK		ENGDIV <sup>5</sup>						—	DFNL			—	DFNH		

POWER-ON RESET:

0 0 1 1 1 1 1 1 0 0 0 0 0 0 0 0

HARD RESET:

U U U U U U U 0 0 0 0 0 0 0 0

NOTES:

1. The hard reset value is a reset configuration word value, extracted from the indicated internal data bus lines.

Refer to [7.5.2 Hard Reset Configuration Word](#).

U = Unaffected by reset

2. RTDIV will be 0 if MODCK[1:3] = 0b000

3. EQ2 = MODCK1

4. EQ3 = ( $\overline{\text{MODCK1}} \& \text{MODCK2} \& \overline{\text{MODCK3}}$ ) | ( $\overline{\text{MODCK1}} \& \text{MODCK2} \& \text{MODCK3}$ ) | ( $\text{MODCK1} \& \overline{\text{MODCK2}} \& \text{MODCK3}$ ). See [Table 8-1](#).

5. On mask sets prior to K62N, ENGDIV defaults to 0b0000001.

**Table 8-9 SCCR Bit Descriptions**

Bit(s)	Name	Description
0	DBCT	Disable backup clock for timers. The DBCT bit controls the timers clock source while the chip is in limp mode. If DBCT is set, the timers clock (tbclk, rtclk) source will not be the backup clock, even if the system clock source is the backup clock ring oscillator. The real-time clock source will be EXTAL or EXTCLK according to RTSEL bit (see description in bit 11 below), and the time base clocks source will be determined according to TBS bit and MODCK1. 0 = If the chip is in limp mode, the timer clock source is the backup (limp) clock 1 = The timer clock source is either the external clock or the crystal (depending on the current clock mode selected)
1:2	COM	Clock output mode. These bits control the output buffer strength of the CLKOUT and external bus pins. These bits can be dynamically changed without generating spikes on the CLKOUT and external bus pins. If CLKOUT is not connected to external circuits, set both bits (disabling CLKOUT) to minimize noise and power dissipation. COM1 is determined by the hard reset configuration word. 00 = Clock output enabled full-strength output buffer, bus pins full drive 01 = Clock output enabled half-strength output buffer, bus pins reduced drive 10 = Clock output disabled, bus pins full drive 11 = Clock output disabled, bus pins reduced drive

**Table 8-9 SCCR Bit Descriptions (Continued)**



Bit(s)	Name	Description
3	DCSLR	Disable clock switching at loss of lock during reset. When DCSLR is clear and limp mode is enabled, the chip will switch automatically to the backup clock if the PLL losses lock during $\overline{\text{HRESET}}$ . When DCSLR is asserted, a PLL loss-of-lock event does not cause clock switching. If $\overline{\text{HRESET}}$ is asserted and DCSLR is set, the chip will not negate $\overline{\text{HRESET}}$ until the PLL acquires lock. 0 = Enable clock switching if the PLL loses lock during reset 1 = Disable clock switching if the PLL loses lock during reset
4	MFPDL	MF and pre-divider lock. Setting this control bit disables writes to the MF and DIVF bits. This helps prevent runaway software from changing the VCO frequency and causing the SPILL to lose lock. In addition, to protect against hardware interference, a hardware reset will be asserted if these fields are changed while LPML is asserted. This bit is writable once after power-on reset. 0 = MF and DIVF fields are writable 1 = MF and DIVF fields are locked
5	LPML	LPM lock. Setting this control bit disables writes to the LPM and CSRC control bits. In addition, for added protection, a hardware reset is asserted if any mode is entered other than normal-high mode. This protects against runaway software causing the MCU to enter low-power modes. (The MSR[POW] bit provides additional protection). LPML is writable once after power-on reset. 0 = LPM and CSRC bits are writable 1 = LPM and CSRC bits are locked and hard reset will occur if the MCU is not in normal-high mode
6	TBS	Time base source. Note that when the chip is operating in limp mode (BUCS = 1), TBS is ignored, and the backup clock is the time base clock source. 0 = Source is OSCCLK divided by either four or 16 1 = Source is system clock divided by 16
7	RTDIV	RTC (and PIT) clock divider. At power-on reset this bit is cleared if MODCK[1:3] are all low; otherwise the bit is set. 0 = RTC and PIT clock divided by four 1 = RTC and PIT clock divided by 256
8	STBUC	Switch to backup clock control. When software sets this bit, the system clock is switched to the on-chip backup clock ring oscillator, and the chip undergoes a hard reset. The STBUC bit is ignored if LME is cleared. 0 = Do not switch to the backup clock ring oscillator 1 = Switch to backup clock ring oscillator
9	—	Reserved
10	PRQEN	Power management request enable 0 = Remains in the lower frequency (defined by DFNL) even if the power management bit in the MSR is reset (normal operational mode) or if there is a pending interrupt from the interrupt controller 1 = Switches to high frequency (defined by DFNH) when the power management bit in the MSR is reset (normal operational mode) or there is a pending interrupt from the interrupt controller
11	RTSEL	RTC circuit input source select. At power-on reset RTSEL receives the value of the MODCK1 bit. Note that if the chip is operating in limp mode (BUCS = 0), the RTSEL bit is ignored, and the backup clock is the clock source for the RT and PIT clocks 0 = OSCM clock is selected as input to RTC and PIT 1 = EXTCLK clock is selected as the RTC and PIT clock source
12	BUCS	Backup clock status. This status bit indicates the current system clock source. When loss of clock is detected and the LME bit is set, the clock source is the backup clock and this bit is set. When the user sets the STBUC bit and LME bit is set, the system switches to the backup clock and BUCS is set. 0 = System clock is not the backup clock 1 = System clock is the backup clock

**Table 8-9 SCCR Bit Descriptions (Continued)**

Bit(s)	Name	Description
13:14	EBDF	External bus division factor. These bits define the frequency division factor between (GCLK1 and GCLK2) and (GCLK1_50 and GCLK2_50). CLKOUT is similar to GCLK2_50. The GCLK2_50 and GCLK1_50 are used by the external bus interface and memory controller in order to interface to the external system. The EBDF bits are initialized during hard reset using the hard reset configuration mechanism. 00 = CLKOUT is GCLK2 divided by 1 01 = CLKOUT is GCLK2 divided by 2 1x = Reserved
15	LME	Limp mode enable. When LME is set, the loss-of-clock monitor is enabled and any detection of loss of clock will switch the system clock automatically to backup clock. It is also possible to switch to the backup clock by setting the STBUC bit.  If LME is cleared, the option of using limp mode is disabled. The loss of clock detector is not active, and any write to STBUC is ignored.  The LME bit is writable once, by software, after power-on reset, when the system clock is not backup clock (BUCS = 0). During power-on reset, the value of LME is determined by the MODCK[1:3] bits. (Refer to <a href="#">Table 8-1</a> .) 0 = Limp mode disabled 1 = Limp mode enabled
16:17	EECLK	Enable engineering clock. This field controls the output buffer strength of the ENGCLK pin. When both bits are set the ENGCLK pin is held in the high state. These bits can be dynamically changed without generating spikes on the ENGCLK pin. If ENGCLK is not connected to external circuits, set both bits (disabling ENGCLK) to minimize noise and power dissipation. For measurement purposes the backup clock (BUCLK) can be driven externally on the ENGCLK pin. 00 = Engineering clock enabled, full-strength output buffer 01 = Engineering clock enabled, half-strength output buffer 10 = BUCLK is the output on the ENGCLK full-strength output buffer 11 = Engineering clock disabled
18:23	ENGDIV	Engineering clock division factor. These bits define the frequency division factor between VCO/2 and ENGCLK. The divider ratio is ENGDIV+1. Division factor can be from 1 (ENGDIV = 0b000000) to 64 (ENGDIV = 0b111111). These bits can be read and written at any time. They are not affected by hard reset but are cleared during power-on reset.  NOTE: If the engineering clock division factor is not a power of two, synchronization between the system and ENGCLK is not guaranteed.  NOTE: The default (Power On Reset) value of ENGDIV will be 0b111111 on all mask sets after K62N. The default for previous mask sets (J76N, K02A, and K83H) is 0b000001.
24	—	Reserved
25:27	DFNL	Division factor low frequency. The user can load these bits with the desired divide value and the CSRC bit to change the frequency. Changing the value of these bits does not result in a loss of lock condition. These bits are cleared by power-on or hard reset. Refer to <a href="#">8.6.1 General System Clocks</a> and <a href="#">Figure 8-5</a> for details on using these bits. 000 = Divide by 2 001 = Divide by 4 010 = Divide by 8 011 = Divide by 16 100 = Divide by 32 101 = Divide by 64 110 = Reserved 111 = Divide by 256



**Table 8-9 SCCR Bit Descriptions (Continued)**



Bit(s)	Name	Description
28	—	Reserved
29:31	DFNH	Division factor high frequency. These bits determine the general system clock frequency during normal mode. Changing the value of these bits does not result in a loss of lock condition. These bits are cleared by power-on or hard reset. The user can load these bits at any time to change the general system clock rate. Note that the GCLKs generated by this division factor are not 50% duty cycle (i.e. CLKOUT). 000 = Divide by 1 001 = Divide by 2 010 = Divide by 4 011 = Divide by 8 100 = Divide by 16 101 = Divide by 32 110 = Divide by 64 111 = Reserved

### 8.12.2 PLL, Low-Power, and Reset-Control Register (PLPRCR)

The PLL, low-power, and reset-control register (PLPRCR) is a 32-bit register powered by the keep alive power supply.

#### PLPRCR — PLL, Low-Power, and Reset-Control Register

**0x2F C284**

MSB 0	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15
MF												RE-SERVE D	LOCS	LOC-SS	SPLS
POWER-ON RESET:															
0 OR 4												0	0	0	0
HARD RESET:															
U	U	U	U	U	U	U	U	U	U	U	U	U	U	U	U
16	17	18	19	20	21	22	23	24	25	26	27	28	29	30	LSB 31
SPLS S	TEXP S	RE-SERVE D	TMIST	RE-SERVE D	CSRC	LPM		CSR	LOL-RE	RE-SERVE D	DIVF				
POWER-ON RESET:															
0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0
HARD RESET:															
U	1	U	0	U	0	0	0	U	U		U	U	U	U	U

U = Unaffected by reset

**Table 8-10 PLPRCR Bit Descriptions**



Bit(s)	Name	Description
0:11	MF	<p>Multiplication factor bits. The output of the VCO is divided to generate the feedback signal to the phase comparator. The MF bits control the value of the divider in the SPLL feedback loop. The phase comparator determines the phase shift between the feedback signal and the reference clock. This difference results in either an increase or decrease in the VCO output frequency.</p> <p>The MF bits can be read and written at any time. However, this field can be write-protected by setting the MF and pre-divider lock (MFPDL) bit in the SCCR. Changing the MF bits causes the SPLL to lose lock. Also, the MF field should not be modified when entering or exiting from low power mode (LPM change), or when back-up clock is active.</p> <p>The normal reset value for the DFNH bits is zero (divide by one). When the PLL is operating in one-to-one mode, the multiplication factor is set to x1 (MF = 0).</p>
12	—	Reserved
13	LOCS	<p>Loss of clock status. When the oscillator or external clock source is not at the minimum frequency, the loss-of-clock circuit asserts the LOCS bit. This bit is cleared when the oscillator or external clock source is functioning normally. This bit is reset only on power-on reset. Writes to this bit have no effect.</p> <p>0 = No loss of oscillator is currently detected 1 = Loss of oscillator is currently detected</p>
14	LOCSS	<p>Loss of clock sticky. If, after negation of <math>\overline{\text{PORESET}}</math>, the loss-of-clock circuit detects that the oscillator or external clock source is not at a minimum frequency, the LOCSS bit is set. LOCSS remains set until software clears it by writing a one to it. A write of zero has no effect on this bit. The reset value is determined during hard reset. The STBUC bit will be set provided the PLL lock condition is not met when <math>\overline{\text{HRESET}}</math> is asserted, and cleared if the PLL is locked when <math>\overline{\text{HRESET}}</math> is asserted.</p> <p>0 = No loss of oscillator has been detected 1 = Loss of oscillator has been detected</p>
15	SPLS	<p>System PLL lock status bit</p> <p>0 = SPLL is currently not locked 1 = SPLL is currently locked</p>
16	SPLSS	<p>SPLL lock status sticky bit. An out-of-lock sets the SPLSS bit. The bit remains set until software clears it by writing a one to it. A write of zero has no effect on this bit. The bit is cleared at power-on reset. This bit is not affected due to a software initiated loss-of-lock (MF change and entering deep-sleep or power-down mode). The SPLSS bit is not affected by hard reset.</p> <p>0 = SPLL has remained in lock 1 = SPLL has gone out of lock at least once (not due to software-initiated loss of lock)</p>
17	TEXPS	<p>Timer expired status bit. This bit controls whether the chip negates the TEXP pin in deep-sleep mode, thus enabling external circuitry to switch off the VDD (power-down mode). When LPM = 11, CSRC = 0, and TEXPS is high, the TEXP pin remains asserted. When LPM = 11, CSRC = 0, and TEXPS is low, the TEXPS pin is negated.</p> <p>To enable automatic wake-up TEXPS is asserted when one of the following occurs:</p> <ul style="list-style-type: none"> <li>• The PIT is expired</li> <li>• The real-time clock alarm is set</li> <li>• The time base clock alarm is set</li> <li>• The decremter exception occurs</li> </ul> <p>The bit remains set until software clears it by writing a one to it. A write of zero has no effect on this bit. TEXPS is set by power-on or hard reset.</p> <p>0 = TEXP is negated in deep-sleep mode 1 = TEXP pin remains asserted always</p>
18	—	Reserved

**Table 8-10 PLPRCR Bit Descriptions (Continued)**



Bit(s)	Name	Description
19	TMIST	Timers interrupt status. TMIST is set when an interrupt from the RTC, PIT, TB or DEC occurs. The TMIST bit is cleared by writing a one to it. Writing a zero has no effect on this bit. The system clock frequency remains at its high frequency value (defined by DFNH) if the TMIST bit is set, even if the CSRC bit in the PLPRCR is set (DFNL enabled) and conditions to switch to normal-low mode do not exist. This bit is cleared during power-on or hard reset. 0 = No timer expired event was detected 1 = A timer expire event was detected
20	—	Reserved
21	CSRC	Clock source. This bit is cleared at hard reset. 0 = General system clock is determined by the DFNH value 1 = General system clock is determined by the DFNL value
22:23	LPM	Low-power mode select. These bits are encoded to provide one normal operating mode and four low-power modes. In normal and doze modes, the system can be in high state (frequency determined by the DFNH bits) or low state (frequency defined by the DFNL bits). The LPM field can be write-protected by setting the LPM and CSRC lock (LPML) bit in the PLPRCR. Refer to <a href="#">Table 8-4</a> and <a href="#">Table 8-5</a> .
24	CSR	Checkstop reset enable. If this bit is set, then an automatic reset is generated when the RCPU signals that it has entered checkstop mode, unless debug mode was enabled at reset. If the bit is clear and debug mode is not enabled, then the USIU will not do anything upon receiving the checkstop signal from the RCPU. If debug mode is enabled, then the part enters debug mode upon entering checkstop mode. In this case, the RCPU will not assert the checkstop signal to the reset circuitry. This bit is writable once after soft reset. 0 = No reset will occur when checkstop is asserted 1 = Reset will occur when checkstop is asserted
25	LOLRE	Loss of lock reset enable 0 = Loss of lock does not cause $\overline{\text{HRESET}}$ assertion 1 = Loss of lock causes $\overline{\text{HRESET}}$ assertion Note: if limp mode is enabled, use the COLIR feature instead of setting the LOLRE bit. See <a href="#">8.12.3 Change of Lock Interrupt Register (COLIR)</a> .
26	—	Reserved
27:31	DIVF	The DIVF bits control the value of the pre-divider in the SPLL circuit. The DIVF bits can be read and written at any time. However, the DIVF field can be write-protected by setting the MF and pre-divider lock (MFPDL) bit in the SCCR. Changing the DIVF bits causes the SPLL to lose lock.

### 8.12.3 Change of Lock Interrupt Register (COLIR)

The COLIR is 16-bit read/write register. It controls the change of lock interrupt generation, and is used for reporting a loss of lock interrupt source. It contains the interrupt request level and the interrupt status bit. This register is readable and writable at any time. A status bit is cleared by writing a one (writing a zero does not affect a status bit's value). The COLIR is memory mapped into the MPC555 / MPC556 USIU register map.

#### COLIR — Change of Lock Interrupt Register

**0x2F C28C**

MSB 0	1	2	3	4	5	6	7	8	9	10	11	12	13	14	LSB 15
COLIRQ								COLIS	Re-served	COLIE	Reserved				

RESET:

0 0 0 0 0 0 0 0 0 0 U U U U U U

U = Unaffected by reset



**Table 8-11 COLIR Bit Descriptions**

Bit(s)	Name	Description
0:7	COLIRQ	Change of lock interrupt request level. These bits determine the interrupt priority level of the change of lock. To specify certain level, the appropriate one of these bits should be set.
8	COLIS	If set ("one"), the bit indicates that a change in the PLL lock status was detected. The PLL was locked and lost lock, or the PLL was unlocked and got locked. The bit should be cleared by writing a one.
9	—	Reserved
10	COLIE	Change of Lock Interrupt enable. If COLIE bit is asserted, an interrupt will generate when the COLIS bit is asserted. 0 = Change of lock Interrupt disable 1 = Change of lock Interrupt enable
10:15	—	Reserved

#### 8.12.4 VDDSRAM Control Register (VSRMCR)

This register contains control bits for enabling or disabling the VDDSRAM supply detection circuit. There are also four bits that indicate the failure detection. All four bits have the same function and are required to improve the detection capability in extreme cases.

#### VSRMCR — VDDSRAM Control Register

**0x2F C290**

MSB 0	1	2	3	4	5	6	7	8	9	10	11	12	13	14	LSB 15
0	LVSRS				VS- RDE	RESERVED									

HARD RESET:

U U U U 0

U = Unaffected by reset

**Table 8-12 VSRMCR Bit Descriptions**

Bit(s)	Name	Description
0	—	Reserved
1:4	LVSRS	Loss of VDDSRAM sticky. These status bits indicate whether a VDDSRAM supply failure occurred. In addition, when the power is turned on for the first time, VDDSRAM rises and these bits are set. The LVSRS bits are cleared by writing them to ones. A write of zero has no effect on these bits. 0 = No VDDSRAM supply failure was detected 1 = VDDSRAM supply failure was detected
5	VSRDE	VDDSRAM detector disable. 0 = VDDSRAM detection circuit is enabled 1 = VDDSRAM detection circuit is disabled
6:15	—	Reserved